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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	5
Program Memory Size	1.5KB (1K x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	41 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.209", 5.30mm Width)
Supplier Device Package	8-SOIJ
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic12c509a-04i-sm">https://www.e-xfl.com/product-detail/microchip-technology/pic12c509a-04i-sm</a>

## 1.0 GENERAL DESCRIPTION

The PIC12C5XX from Microchip Technology is a family of low-cost, high performance, 8-bit, fully static, EEPROM/EPROM/ROM-based CMOS microcontrollers. It employs a RISC architecture with only 33 single word/single cycle instructions. All instructions are single cycle (1  $\mu$ s) except for program branches which take two cycles. The PIC12C5XX delivers performance an order of magnitude higher than its competitors in the same price category. The 12-bit wide instructions are highly symmetrical resulting in 2:1 code compression over other 8-bit microcontrollers in its class. The easy to use and easy to remember instruction set reduces development time significantly.

The PIC12C5XX products are equipped with special features that reduce system cost and power requirements. The Power-On Reset (POR) and Device Reset Timer (DRT) eliminate the need for external reset circuitry. There are four oscillator configurations to choose from, including INTRC internal oscillator mode and the power-saving LP (Low Power) oscillator mode. Power saving SLEEP mode, Watchdog Timer and code protection features also improve system cost, power and reliability.

The PIC12C5XX are available in the cost-effective One-Time-Programmable (OTP) versions which are suitable for production in any volume. The customer can take full advantage of Microchip's price leadership in OTP microcontrollers while benefiting from the OTP's flexibility.

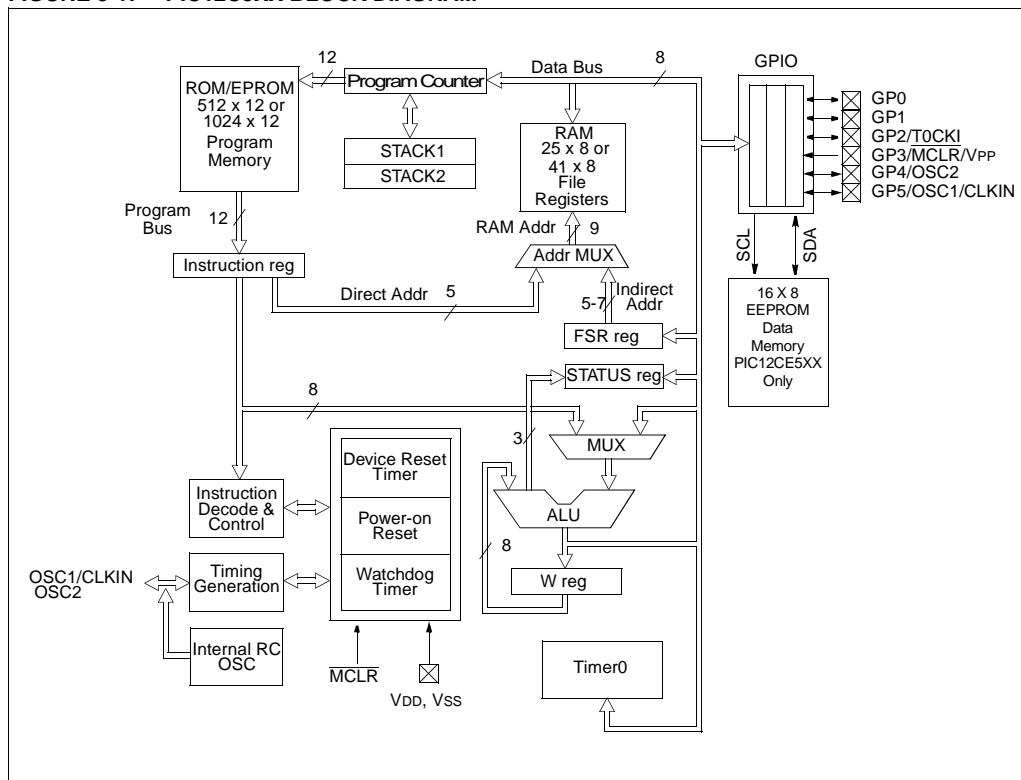
The PIC12C5XX products are supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a 'C' compiler, fuzzy logic support tools, a low-cost development programmer, and a full featured programmer. All the tools are supported on IBM® PC and compatible machines.

## 1.1 Applications

The PIC12C5XX series fits perfectly in applications ranging from personal care appliances and security systems to low-power remote transmitters/receivers. The EPROM technology makes customizing application programs (transmitter codes, appliance settings, receiver frequencies, etc.) extremely fast and convenient, while the EEPROM data memory technology allows for the changing of calibration factors and security codes. The small footprint packages, for through hole or surface mounting, make this microcontroller series perfect for applications with space limitations. Low-cost, low-power, high performance, ease of use and I/O flexibility make the PIC12C5XX series very versatile even in areas where no microcontroller use has been considered before (e.g., timer functions, replacement of "glue" logic and PLD's in larger systems, coprocessor applications).

# PIC12C5XX

**FIGURE 3-1: PIC12C5XX BLOCK DIAGRAM**



## 4.8 Indirect Data Addressing: INDF and FSR Registers

The INDF register is not a physical register. Addressing INDF actually addresses the register whose address is contained in the FSR register (FSR is a *pointer*). This is indirect addressing.

### EXAMPLE 4-1: INDIRECT ADDRESSING

- Register file 07 contains the value 10h
- Register file 08 contains the value 0Ah
- Load the value 07 into the FSR register
- A read of the INDF register will return the value of 10h
- Increment the value of the FSR register by one (FSR = 08)
- A read of the INDR register now will return the value of 0Ah.

Reading INDF itself indirectly (FSR = 0) will produce 00h. Writing to the INDF register indirectly results in a no-operation (although STATUS bits may be affected).

A simple program to clear RAM locations 10h-1Fh using indirect addressing is shown in Example 4-2.

### EXAMPLE 4-2: HOW TO CLEAR RAM USING INDIRECT ADDRESSING

```

movlw 0x10 ;initialize pointer
movwf FSR ; to RAM
NEXT   clrf INDF ;clear INDF register
       incf FSR,F ;inc pointer
       btfsc FSR,4 ;all done?
       goto NEXT ;NO, clear next

CONTINUE
:      ;YES, continue
    
```

The FSR is a 5-bit wide register. It is used in conjunction with the INDF register to indirectly address the data memory area.

The FSR<4:0> bits are used to select data memory addresses 00h to 1Fh.

**PIC12C508/PIC12C508A/PIC12CE518:** Does not use banking. FSR<7:5> are unimplemented and read as '1's.

**PIC12C509/PIC12C509A/PIC12CR509A/**

**PIC12CE519:** Uses FSR<5>. Selects between bank 0 and bank 1. FSR<7:6> is unimplemented, read as '1'.

FIGURE 4-9: DIRECT/INDIRECT ADDRESSING

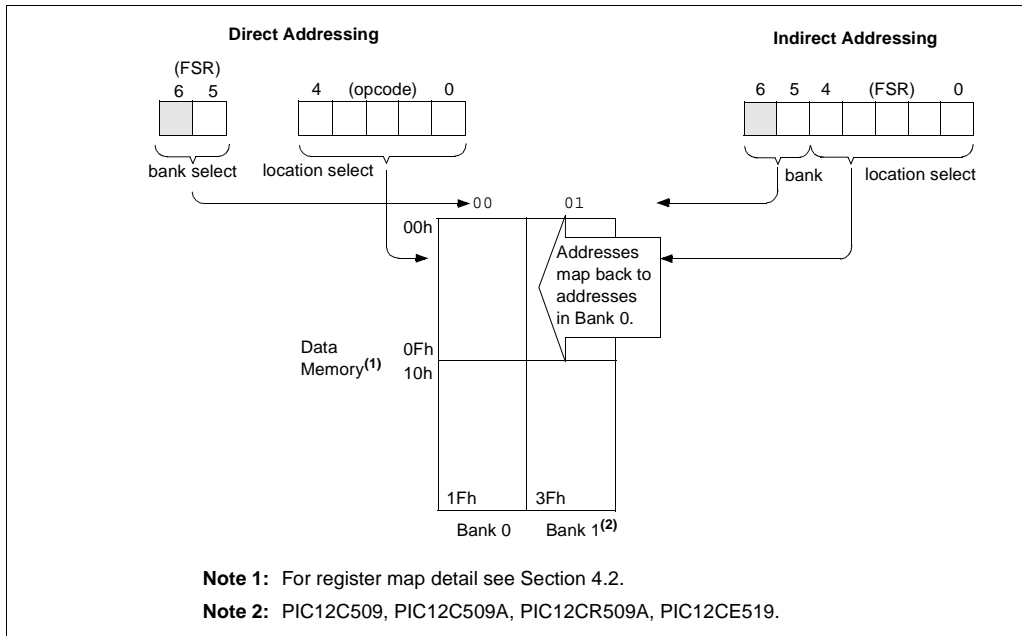


FIGURE 6-2: TIMER0 TIMING: INTERNAL CLOCK/NO PRESCALE

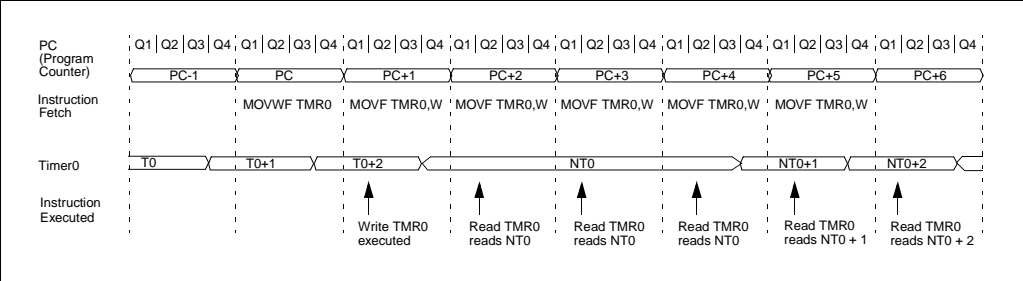


FIGURE 6-3: TIMER0 TIMING: INTERNAL CLOCK/PRESCALE 1:2

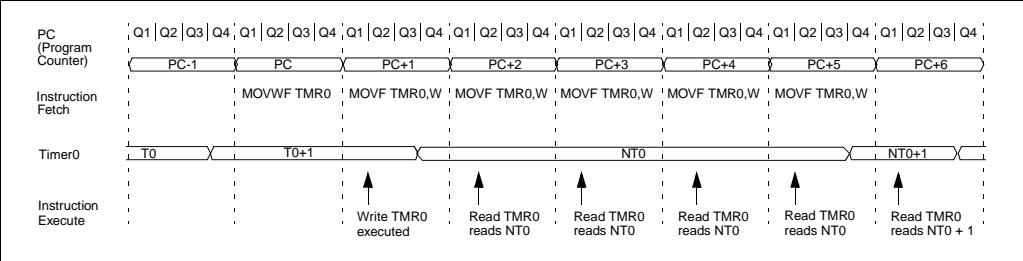


TABLE 6-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-On Reset	Value on All Other Resets
01h	TMR0	Timer0 - 8-bit real-time clock/counter								xxxx xxxx	uuuu uuuu
N/A	OPTION	GPWU	GPPU	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
N/A	TRIS	—	—	GP5	GP4	GP3	GP2	GP1	GP0	--11 1111	--11 1111

Legend: Shaded cells not used by Timer0, - = unimplemented, x = unknown, u = unchanged,

## 6.1 Using Timer0 with an External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (TOSC) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

### 6.1.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 6-4). Therefore, it is necessary for T0CKI to be high for at least 2TOSC (and a small RC delay of 20 ns) and low for at least 2TOSC (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple counter-type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for T0CKI to have a period of at least 4TOSC (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T0CKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

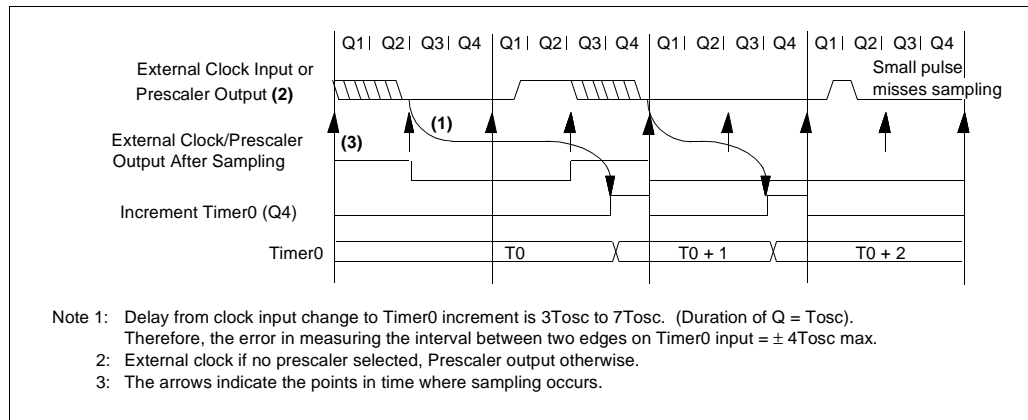
### 6.1.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 6-4 shows the delay from the external clock edge to the timer incrementing.

### 6.1.3 OPTION REGISTER EFFECT ON GP2 TRIS

If the option register is set to read TIMER0 from the pin, the port is forced to an input regardless of the TRIS register setting.

**FIGURE 6-4: TIMER0 TIMING WITH EXTERNAL CLOCK**



## 8.12 In-Circuit Serial Programming

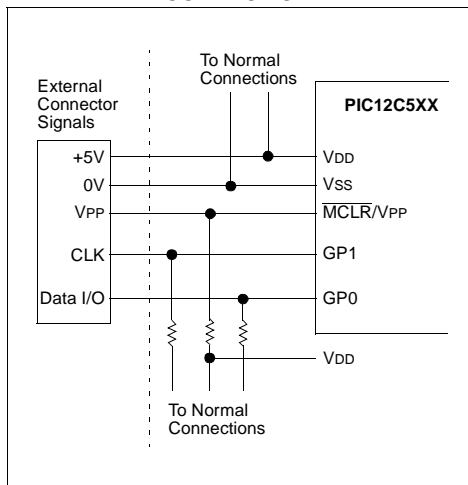
The PIC12C5XX microcontrollers with EPROM program memory can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

The device is placed into a program/verify mode by holding the GP1 and GP0 pins low while raising the MCLR (VPP) pin from  $V_{IL}$  to  $V_{IH}$  (see programming specification). GP1 becomes the programming clock and GP0 becomes the programming data. Both GP1 and GP0 are Schmitt Trigger inputs in this mode.

After reset, a 6-bit command is then supplied to the device. Depending on the command, 14-bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the PIC12C5XX Programming Specifications.

A typical in-circuit serial programming connection is shown in Figure 8-16.

**FIGURE 8-16: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION**



## OPTION Load OPTION Register

Syntax: [ *label* ] OPTION

Operands: None

Operation: (W) → OPTION

Status Affected: None

Encoding: 

0000	0000	0010
------	------	------

Description: The content of the W register is loaded into the OPTION register.

Words: 1

Cycles: 1

Example: OPTION

Before Instruction  
W = 0x07

After Instruction  
OPTION = 0x07

## RETLW Return with Literal in W

Syntax: [ *label* ] RETLW k

Operands:  $0 \leq k \leq 255$

Operation: k → (W);  
TOS → PC

Status Affected: None

Encoding: 

1000	kkkk	kkkk
------	------	------

Description: The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two cycle instruction.

Words: 1

Cycles: 2

Example:

```
CALL TABLE ;W contains
               ;table offset
               ;value.
               ;W now has table
               ;value.
               ;
TABLE          ADDWF PC ;W = offset
               RETLW k1 ;Begin table
               RETLW k2 ;
               ;
               ;
               RETLW kn ; End of table
```

Before Instruction  
W = 0x07

After Instruction  
W = value of k8

## RLF Rotate Left f through Carry

Syntax: [ *label* ] RLF f,d

Operands:  $0 \leq f \leq 31$   
 $d \in [0,1]$

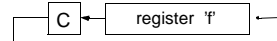
Operation: See description below

Status Affected: C

Encoding: 

0011	01df	ffff
------	------	------

Description: The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'.



Words: 1

Cycles: 1

Example: RLF REG1,0

Before Instruction  
REG1 = 1110 0110  
C = 0

After Instruction  
REG1 = 1110 0110  
W = 1100 1100  
C = 1

## RRF Rotate Right f through Carry

Syntax: [ *label* ] RRF f,d

Operands:  $0 \leq f \leq 31$   
 $d \in [0,1]$

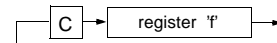
Operation: See description below

Status Affected: C

Encoding: 

0011	00df	ffff
------	------	------

Description: The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.



Words: 1

Cycles: 1

Example: RRF REG1,0

Before Instruction  
REG1 = 1110 0110  
C = 0

After Instruction  
REG1 = 1110 0110  
W = 0111 0011  
C = 0



NOTES:

## 10.10 MPLAB Integrated Development Environment Software

The MPLAB IDE Software brings an ease of software development previously unseen in the 8-bit microcontroller market. MPLAB is a windows based application which contains:

- A full featured editor
- Three operating modes
  - editor
  - emulator
  - simulator
- A project manager
- Customizable tool bar and key mapping
- A status bar with project information
- Extensive on-line help

MPLAB allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PICmicro<sup>®</sup> tools (automatically updates all project information)
- Debug using:
  - source files
  - absolute listing file

The ability to use MPLAB with Microchip's simulator allows a consistent platform and the ability to easily switch from the low cost simulator to the full featured emulator with minimal retraining due to development tools.

## 10.11 Assembler (MPASM)

The MPASM Universal Macro Assembler is a PC-hosted symbolic assembler. It supports all microcontroller series including the PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX, and PIC17CXX families.

MPASM offers full featured Macro capabilities, conditional assembly, and several source and listing formats. It generates various object code formats to support Microchip's development tools as well as third party programmers.

MPASM allows full symbolic debugging from MPLAB-ICE, Microchip's Universal Emulator System.

MPASM has the following features to assist in developing software for specific use applications.

- Provides translation of Assembler source code to object code for all Microchip microcontrollers.
- Macro assembly capability.
- Produces all the files (Object, Listing, Symbol, and special) required for symbolic debug with Microchip's emulator systems.
- Supports Hex (default), Decimal and Octal source and listing formats.

MPASM provides a rich directive language to support programming of the PICmicro<sup>®</sup>. Directives are helpful in making the development of your assemble source code shorter and more maintainable.

## 10.12 Software Simulator (MPLAB-SIM)

The MPLAB-SIM Software Simulator allows code development in a PC host environment. It allows the user to simulate the PICmicro<sup>®</sup> series microcontrollers on an instruction level. On any given instruction, the user may examine or modify any of the data areas or provide external stimulus to any of the pins. The input/output radix can be set by the user and the execution can be performed in; single step, execute until break, or in a trace mode.

MPLAB-SIM fully supports symbolic debugging using MPLAB-C17 and MPASM. The Software Simulator offers the low cost flexibility to develop and debug code outside of the laboratory environment making it an excellent multi-project software development tool.

## 10.13 MPLAB-C17 Compiler

The MPLAB-C17 Code Development System is a complete ANSI 'C' compiler and integrated development environment for Microchip's PIC17CXXX family of microcontrollers. The compiler provides powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compiler provides symbol information that is compatible with the MPLAB IDE memory display.

## 10.14 Fuzzy Logic Development System (fuzzyTECH-MP)

*fuzzyTECH-MP* fuzzy logic development tool is available in two versions - a low cost introductory version, MP Explorer, for designers to gain a comprehensive working knowledge of fuzzy logic system design; and a full-featured version, *fuzzyTECH-MP*, Edition for implementing more complex systems.

Both versions include Microchip's *fuzzyLAB*<sup>™</sup> demonstration board for hands-on experience with fuzzy logic systems implementation.

## 10.15 SEEVAL<sup>®</sup> Evaluation and Programming System

The SEEVAL SEEPRO Designer's Kit supports all Microchip 2-wire and 3-wire Serial EEPROMs. The kit includes everything necessary to read, write, erase or program special features of any Microchip SEEPRO product including Smart Serials<sup>™</sup> and secure serials. The Total Endurance<sup>™</sup> Disk is included to aid in trade-off analysis and reliability calculations. The total kit can significantly reduce time-to-market and result in an optimized system.

# PIC12C5XX

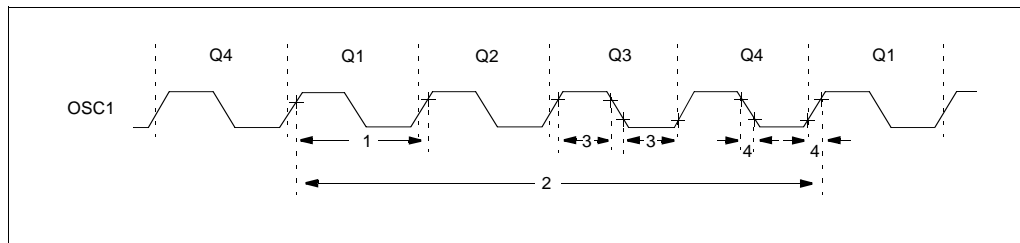
**TABLE 11-1: PULL-UP RESISTOR RANGES - PIC12C508/C509**

V <sub>DD</sub> (Volts)	Temperature (°C)	Min	Typ	Max	Units
GP0/GP1					
2.5	–40	38K	42K	63K	Ω
	25	42K	48K	63K	Ω
	85	42K	49K	63K	Ω
	125	50K	55K	63K	Ω
5.5	–40	15K	17K	20K	Ω
	25	18K	20K	23K	Ω
	85	19K	22K	25K	Ω
	125	22K	24K	28K	Ω
GP3					
2.5	–40	285K	346K	417K	Ω
	25	343K	414K	532K	Ω
	85	368K	457K	532K	Ω
	125	431K	504K	593K	Ω
5.5	–40	247K	292K	360K	Ω
	25	288K	341K	437K	Ω
	85	306K	371K	448K	Ω
	125	351K	407K	500K	Ω

\* These parameters are characterized but not tested.

## 11.4 Timing Diagrams and Specifications

**FIGURE 11-2: EXTERNAL CLOCK TIMING - PIC12C508/C509**



**TABLE 11-2: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC12C508/C509**

AC Characteristics		Standard Operating Conditions (unless otherwise specified)					
		Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial), $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial), $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended)					
		Operating Voltage $V_{DD}$ range is described in Section 11.1					
Parameter No.	Sym	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Conditions
	Fosc	External CLKIN Frequency <sup>(2)</sup>	DC	—	4	MHz	XT osc mode
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency <sup>(2)</sup>	0.1	—	4	MHz	XT osc mode
			DC	—	200	kHz	LP osc mode
1	Tosc	External CLKIN Period <sup>(2)</sup>	250	—	—	ns	EXTRC osc mode
			250	—	—	ns	XT osc mode
			5	—	—	ms	LP osc mode
		Oscillator Period <sup>(2)</sup>	250	—	—	ns	EXTRC osc mode
			250	—	10,000	ns	XT osc mode
			5	—	—	ms	LP osc mode
2	Tcy	Instruction Cycle Time <sup>(3)</sup>	—	4/FOSC	—	—	
3	TosL, TosH	Clock in (OSC1) Low or High Time	50*	—	—	ns	XT oscillator
			2*	—	—	ms	LP oscillator
4	TosR, TosF	Clock in (OSC1) Rise or Fall Time	—	—	25*	ns	XT oscillator
			—	—	50*	ns	LP oscillator

\* These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

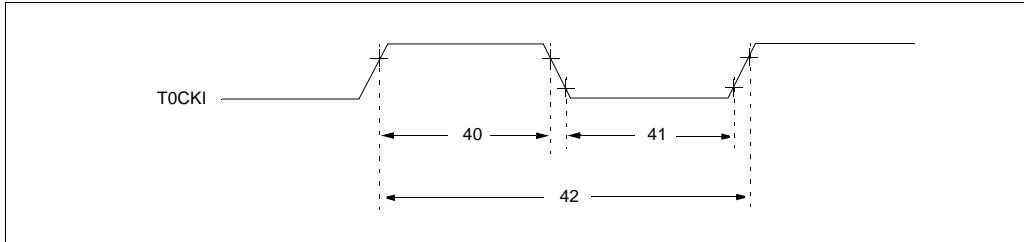
2: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

3: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

# PIC12C5XX

**FIGURE 11-5: TIMER0 CLOCK TIMINGS - PIC12C508/C509**



**TABLE 11-7: TIMER0 CLOCK REQUIREMENTS - PIC12C508/C509**

AC Characteristics			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended) Operating Voltage $V_{DD}$ range is described in Section 11.1.				
Parameter No.	Sym	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	$10^*$	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	$10^*$	—	—	ns	
42	Tt0P	T0CKI Period	$20 \text{ or } \frac{T_{CY} + 40^*}{N}$	—	—	ns	Whichever is greater. N = Prescale Value (1, 2, 4,..., 256)

\* These parameters are characterized but not tested.

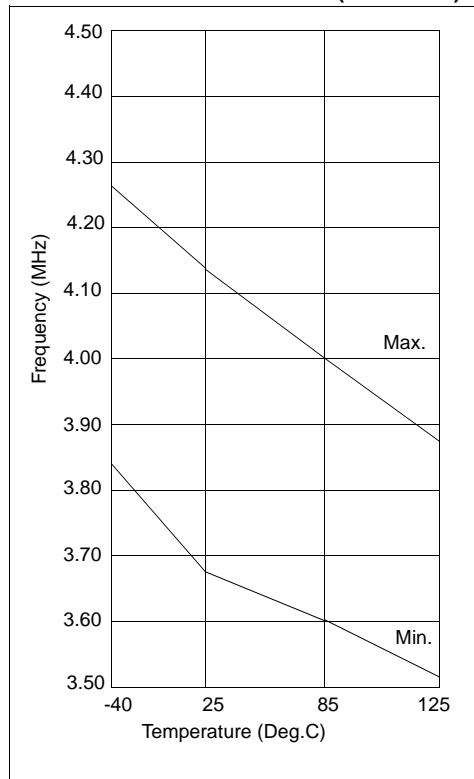
Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

## 12.0 DC AND AC CHARACTERISTICS - PIC12C508/PIC12C509

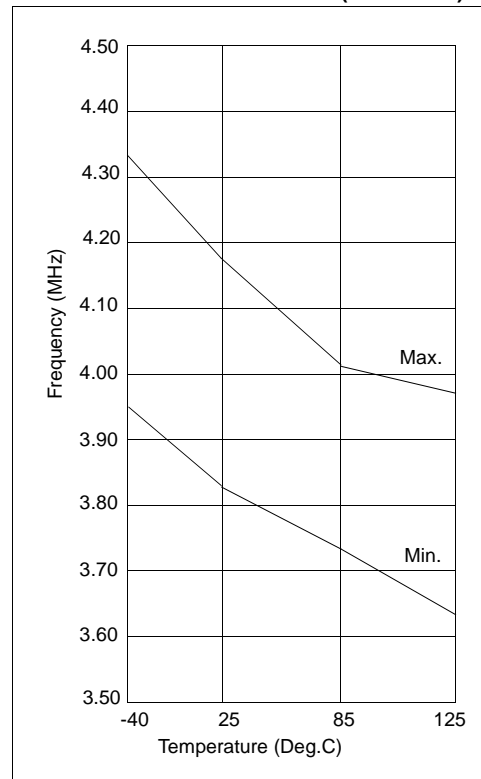
The graphs and tables provided in this section are for design guidance and are not tested. In some graphs or tables the data presented are outside specified operating range (e.g., outside specified VDD range). This is for information only and devices will operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean + 3 $\sigma$ ) and (mean - 3 $\sigma$ ) respectively, where  $\sigma$  is standard deviation.

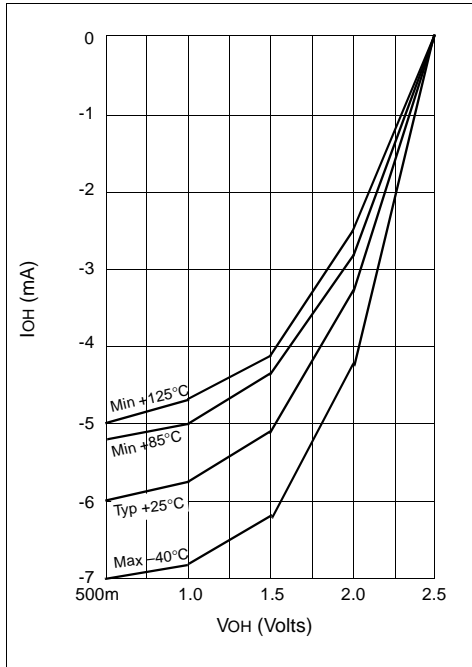
**FIGURE 12-1: CALIBRATED INTERNAL RC FREQUENCY RANGE VS. TEMPERATURE (VDD = 2.5V)**



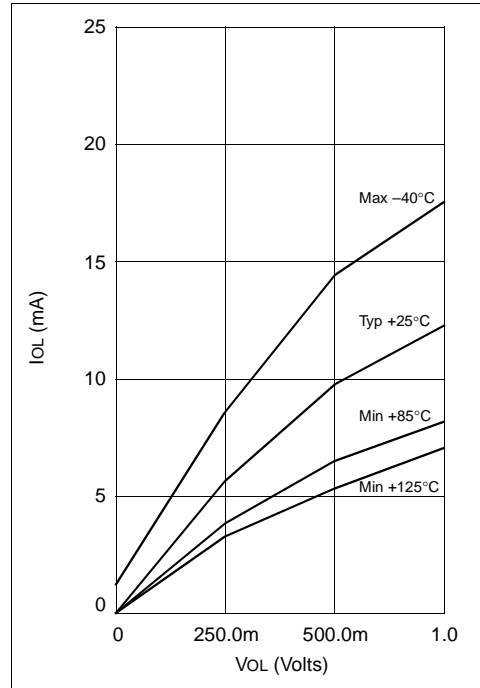
**FIGURE 12-2: CALIBRATED INTERNAL RC FREQUENCY RANGE VS. TEMPERATURE (VDD = 5.0V)**



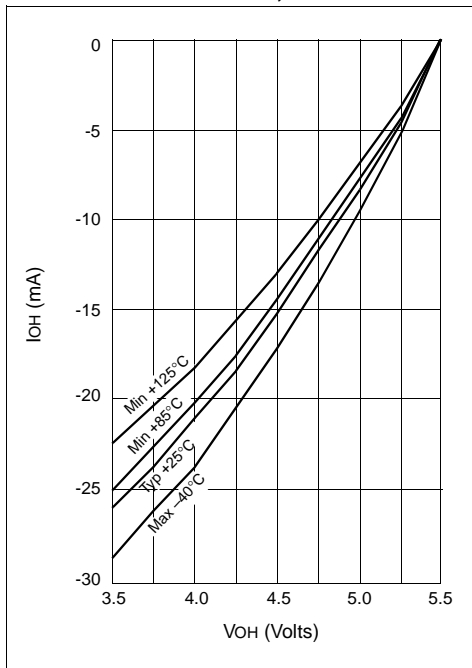
**FIGURE 12-5:  $I_{OH}$  vs.  $V_{OH}$ ,  $V_{DD} = 2.5\text{ V}$**



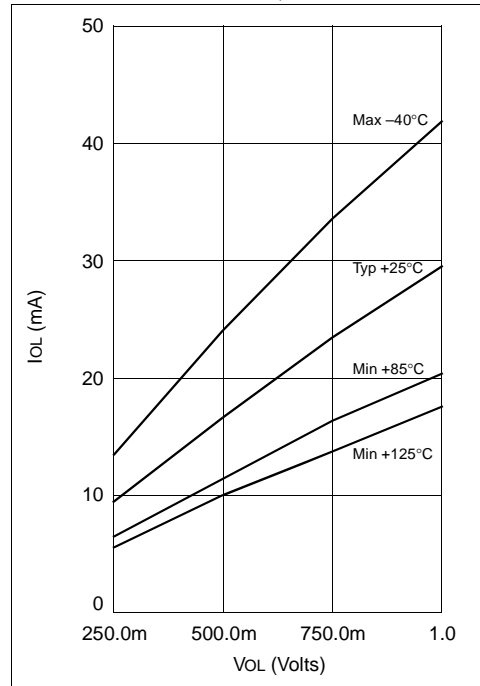
**FIGURE 12-7:  $I_{OL}$  vs.  $V_{OL}$ ,  $V_{DD} = 2.5\text{ V}$**



**FIGURE 12-6:  $I_{OH}$  vs.  $V_{OH}$ ,  $V_{DD} = 5.5\text{ V}$**



**FIGURE 12-8:  $I_{OL}$  vs.  $V_{OL}$ ,  $V_{DD} = 5.5\text{ V}$**



## 13.4 DC CHARACTERISTICS:

**PIC12LC508A/509A (Commercial, Industrial)**  
**PIC12LC518/519 (Commercial, Industrial)**  
**PIC12LCR509A (Commercial, Industrial)**

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise specified)					
		Operating temperature 0°C ≤ TA ≤ +70°C (commercial) -40°C ≤ TA ≤ +85°C (industrial)					
		Operating voltage VDD range as described in DC spec Section 13.1 and Section 13.2.					
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D030	<b>Input Low Voltage</b> I/O ports with TTL buffer	VIL	VSS	-	0.8V	V	For 4.5V ≤ VDD ≤ 5.5V otherwise
D031	with Schmitt Trigger buffer		VSS	-	0.15VDD	V	
D032	MCLR, GP2/T0CKI (in EXTRC mode)		VSS	-	0.2VDD	V	
D033	OSC1 (in EXTRC mode)		VSS	-	0.2VDD	V	
D033	OSC1 (in XT and LP)		VSS	-	0.3VDD	V	
D040	<b>Input High Voltage</b> I/O ports with TTL buffer	VIH	0.25VDD + 0.8V	-	VDD	V	4.5V ≤ VDD ≤ 5.5V otherwise For entire VDD range
D040A	with Schmitt Trigger buffer		2.0V	-	VDD	V	
D041	MCLR, GP2/T0CKI		0.8VDD	-	VDD	V	
D042	OSC1 (XT and LP)		0.8VDD	-	VDD	V	
D042A	OSC1 (in EXTRC mode)		0.7VDD	-	VDD	V	
D043	OSC1 (in EXTRC mode)		0.9VDD	-	VDD	V	Note 1
D070	GPIO weak pull-up current (Note 4)	IPUR	30	250	400	μA	VDD = 5V, VPIN = VSS
	MCLR pull-up current	-	-	-	30	μA	VDD = 5V, VPIN = VSS
D060	<b>Input Leakage Current</b> (Notes 2, 3) I/O ports	IIL	-	-	±1	μA	VSS ≤ VPIN ≤ VDD, Pin at hi-impedance
D061	T0CKI		-	-	±5	μA	VSS ≤ VPIN ≤ VDD
D063	OSC1		-	-	±5	μA	VSS ≤ VPIN ≤ VDD, XT and LP osc configuration
D080	<b>Output Low Voltage</b> I/O ports	VOL	-	-	0.6	V	IoL = 8.5 mA, VDD = 4.5V, -40°C to +85°C
D080A			-	-	0.6	V	IoL = 7.0 mA, VDD = 4.5V, -40°C to +125°C
D090	<b>Output High Voltage</b> I/O ports (Note 3)	VOH	VDD - 0.7	-	-	V	IoH = -3.0 mA, VDD = 4.5V, -40°C to +85°C
D090A			VDD - 0.7	-	-	V	IoH = -2.5 mA, VDD = 4.5V, -40°C to +125°C
D100	<b>Capacitive Loading Specs on Output Pins</b> OSC2 pin	COSC2	-	-	15	pF	In XT and LP modes when external clock is used to drive OSC1.
D101	All I/O pins	CIO	-	-	50	pF	

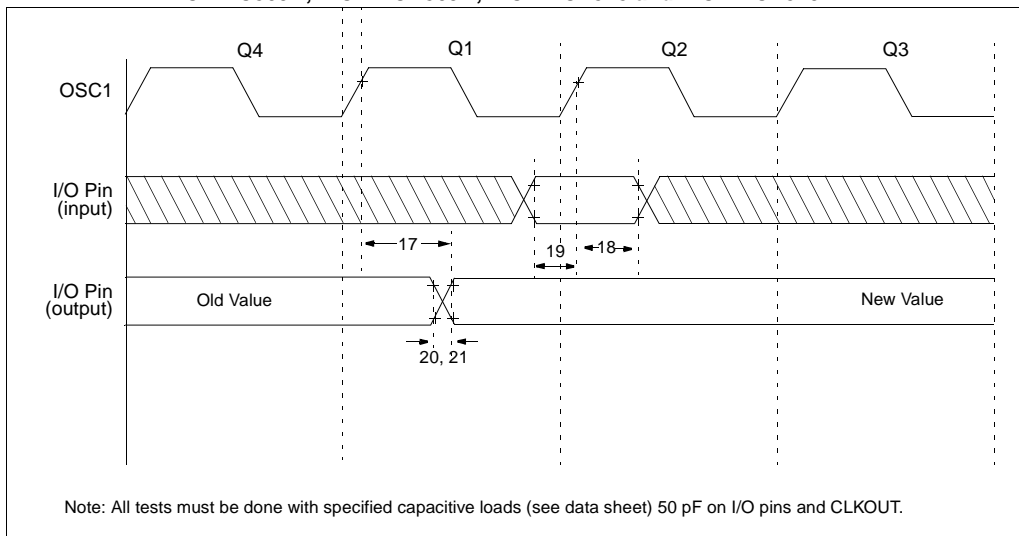
† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1: In EXTRC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC12C5XX be driven with external clock in RC mode.
- Note 2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- Note 3: Negative current is defined as coming out of the pin.
- Note 4: This spec. applies when GP3/MCLR is configured as MCLR. The leakage current of the MCLR circuit is higher than the standard I/O logic.



# PIC12C5XX

**FIGURE 13-3: I/O TIMING - PIC12C508A, PIC12C509A, PIC12CE518, PIC12CE519, PIC12LC508A, PIC12LC509A, PIC12LCR509A, PIC12LCE518 and PIC12LCE519**



**TABLE 13-4: TIMING REQUIREMENTS - PIC12C508A, PIC12C509A, PIC12CE518, PIC12CE519, PIC12LC508A, PIC12LC509A, PIC12LCR509A, PIC12LCE518 and PIC12LCE519**

AC Characteristics		Standard Operating Conditions (unless otherwise specified)				
		Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended)				
		Operating Voltage $V_{DD}$ range is described in Section 13.1				
Parameter No.	Sym	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units
17	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid <sup>(3)</sup>	—	—	100*	ns
18	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	—	—	ns
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	—	—	ns
20	TioR	Port output rise time <sup>(2, 3)</sup>	—	10	25**	ns
21	TioF	Port output fall time <sup>(2, 3)</sup>	—	10	25**	ns

\* These parameters are characterized but not tested.

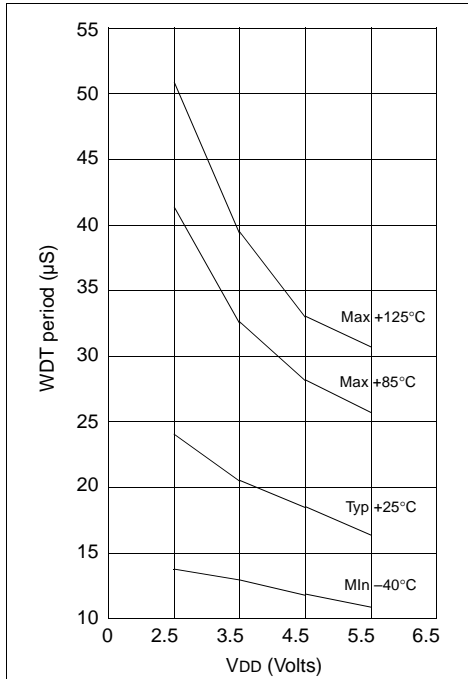
\*\* These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

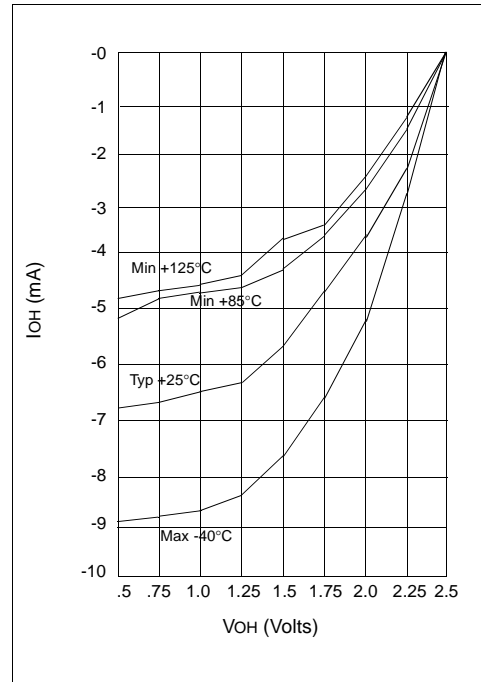
2: Measurements are taken in EXTRC mode.

3: See Figure 13-1 for loading conditions.

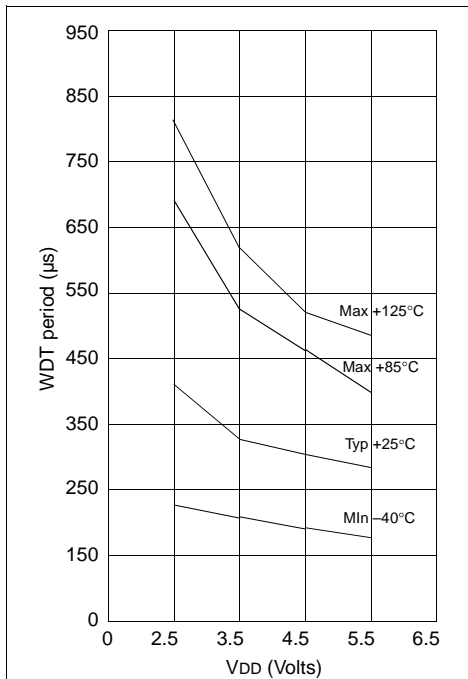
**FIGURE 14-5: WDT TIMER TIME-OUT PERIOD vs.  $V_{DD}$**



**FIGURE 14-7:  $I_{OH}$  vs.  $V_{OH}$ ,  $V_{DD} = 2.5$  V**



**FIGURE 14-6: SHORT DRT PERIOD VS.  $V_{DD}$**



**FIGURE 14-8:  $I_{OH}$  vs.  $V_{OH}$ ,  $V_{DD} = 3.5$  V**

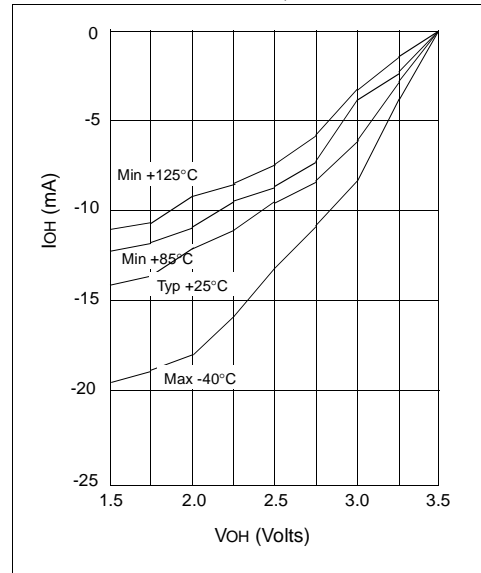


FIGURE 14-9:  $I_{OL}$  vs.  $V_{OL}$ ,  $V_{DD} = 2.5\text{ V}$

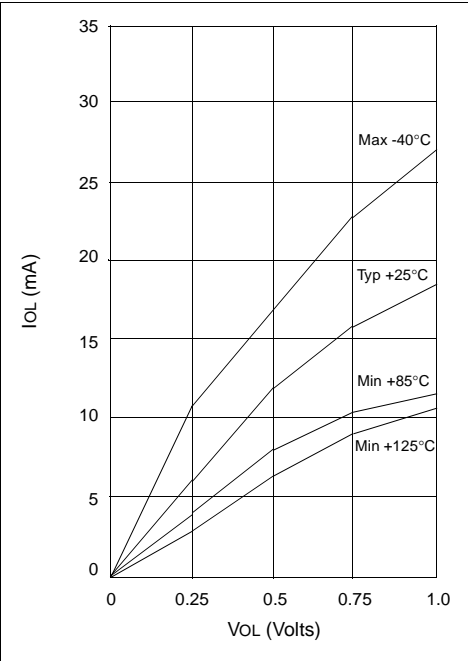


FIGURE 14-11:  $I_{OH}$  vs.  $V_{OH}$ ,  $V_{DD} = 5.5\text{ V}$

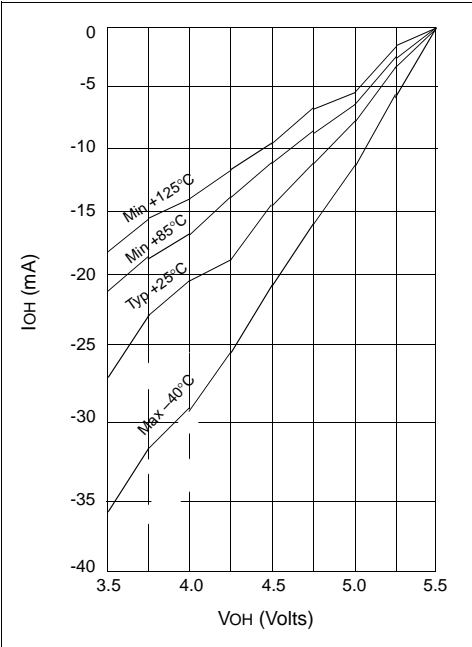


FIGURE 14-10:  $I_{OL}$  vs.  $V_{OL}$ ,  $V_{DD} = 3.5\text{ V}$

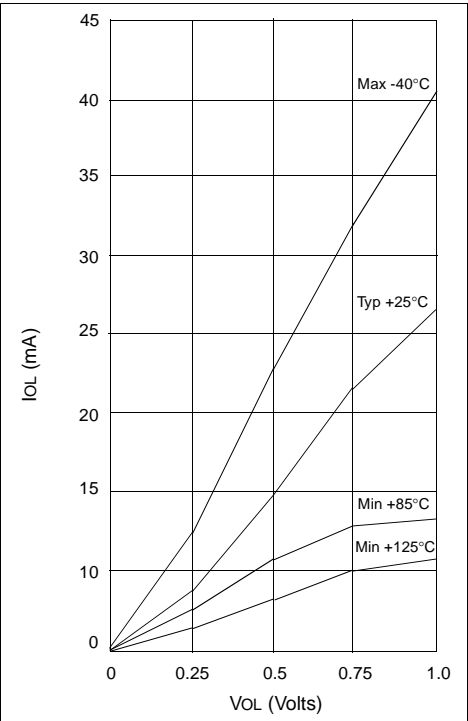
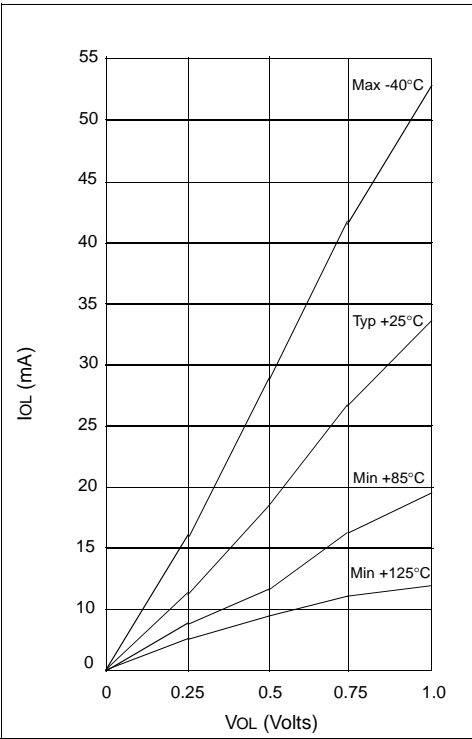


FIGURE 14-12:  $I_{OL}$  vs.  $V_{OL}$ ,  $V_{DD} = 5.5\text{ V}$



# PIC12C5XX

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NOTES:



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